PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JUNG HYEONG HA	06/25/2018
DONG HUN KIM	06/25/2018
SUNG-HUN SIM	06/25/2018
HYOUNGSAM YIM	06/25/2018

RECEIVING PARTY DATA

Name:	LG ELECTRONICS INC.	
Street Address:	128, YEOUI-DAERO, YEONGDEUNGPO-GU	
City:	SEOUL	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	07336	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16023094

CORRESPONDENCE DATA

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	7989.00106.US00
NAME OF SUBMITTER:	YONG S. CHOI
SIGNATURE:	/Yong S. Choi/
DATE SIGNED:	06/29/2018

Total Attachments: 2

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PATENT 504984259 REEL: 046238 FRAME: 0460

Docket No.: 7989.00106.US00

Assignment of Application

WHEREAS, I (WE)	Jung Hyeong HA, Dong Hun KIM, Sung-Hun SIM and Kyoungsam YIM		
			, respectively,
have invented certain new a	and useful improvements in:		
1	HIELDING ELECTROM NG APPLIANCE THERE		WAVES,
for which an application for	Letters Patent was executed on		

(Application No.	16/023,094	, Filed	June 29, 2018), and
WHEREAS,	LG ELECTRONICS INC.			
(hereinafter referred to as "ASSIGNEE") having a place of business at:				
128, Yeoui-daero, Yeongdeungpo-gu, Seoul 07336, Republic of Korea				

is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and Its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behalf of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and

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enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of Dentons US LLP, Attorneys at Law, 1900 K Street, N.W., Washington, D.C. 20006 the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

rate: 2018. 6. 15 (Signature of Inventor)

(Signature of Inventor)

Jung Hyeong HA

Date: 2018.6.25

(Signature of Inventor)

Dong Hun KIM

Date: 2018.6.29

(Signature of Inventor)
Sung-Hun SIM

Date: 2016.6.25

(Signature of Inventor)

Kyoungsam YIM

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